



32x TI-SAR ADC

The image shows a microchip die with a central processing area and peripheral blocks. The central area is divided into three main sections: a large left section for the PPAC equalizer, a middle section for the CHEST engine, and a narrow right section for SRAM. Two ADC blocks are located at the top and bottom of the central area. The entire die is surrounded by a spiral wire bond structure.

4x PPAC
finite-alphabet
spatial equalizer

CHEST
(BEACHES
engine)

S
R
A
M

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